WINSTAR Display Co.,Ltd.

華凌光電股份有限公司

SPECIFICATION

CUSTOMER :

MODULE NO.:   WO256128A-TDI#

APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION: DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
F	2020/08/28		Add Interface Modify Contour drawing

Winstar Display Co.,

華凌光電股份有限公司

		MODLE NO：	

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2015/12/21		First issue
A	2016/01/05		Add External Power Supply Circuit.
B	2016/01/27		Modify Precautions in use of LCD Modules & Static electricity test
C	2016/11/21		Add FPC bending rule
D	2019/08/27		Modify Material List of Components for RoHs
E	2019/12/17		Modify Precautions in use of LCD Modules
F	2020/08/28		Add Interface Modify Contour drawing

Contents

1.Module Classification Information

<u>W</u>   <u>O</u>   <u>256128</u>   <u>A</u>   −   <u>T</u>   <u>D</u>   <u>I</u>   −   <u>#</u>

①   ②   ③   ④   ⑤   ⑥   ⑦   ⑧

① Brand：WINSTAR DISPLAY CORPORATION

② Display Type：H→Character Type, G→Graphic Type , X→TAB Type, O→COG Type

③ Display Font： 256 * 128 dot

④ Model serials no.

⑤ Backlight Type：

N→Without backlight	T→LED, White	L→LED, Full color
B→EL, Blue green	A→LED, Amber	J→DIP LED,Blue
D→EL, Green	R→LED, Red	K→DIP LED,White
W→EL, White	O→LED, Orange	E→DIP LED, Yellow Green
M→EL, Yellow Green	G→LED, Green	H→DIP LED,Amber
F→CCFL, White	P→LED, Blue	I→DIP LED, Red
Y→LED, Yellow Green	X→LED, Dual color	
G→LED, Green	C→LED, Full color	

⑥ LCD Mode：

B→TN Positive, Gray	V→FSTN Negative, Blue
N→TN Negative,	T→FSTN Negative, Black
L→VA Negative	D→FSTN Negative (Double film)
H→ HTN Positive, Gray	F→FSTN Positive
I→HTN Negative, Black	K→FSC Negative
U→HTN Negative, Blue	S→FSC Positive
M→STN Negative, Blue	E→ISTN Negative, Black
G→STN Positive, Gray	C→CSTN Negative, Black
Y→STN Positive, Yellow Green	A→ASTN Negative, Black

⑦ LCD Polarize Type/ Temperature range/ View direction

A→Reflective, N.T, 6:00	H→Transflective, W.T,6:00
D→Reflective, N.T, 12:00	K→Transflective, W.T,12:00
G→Reflective, W. T, 6:00	C→Transmissive, N.T,6:00
J→Reflective, W. T, 12:00	F→Transmissive, N.T,12:00
B→Transflective, N.T,6:00	I→Transmissive, W. T, 6:00
E→Transflective, N.T.12:00	L→Transmissive, W.T,12:00

⑧ Special Code   #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

(1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.

(2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.

(3)Don't disassemble the LCM.

(4)Don't operate it above the absolute maximum rating.

(5)Don't drop, bend or twist LCM.

(6)Soldering: only to the I/O terminals.

(7)Storage: please storage in anti-static electricity container and clean environment.

(8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)

(9)Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)

(10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.

(11) The limitation of FPC bending
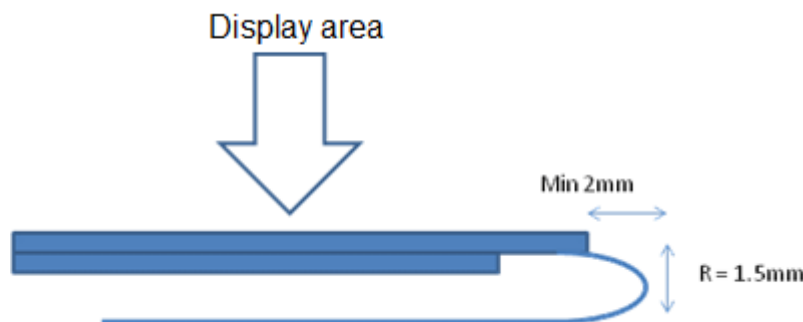
(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit
Number of dots	256 x 128	—
Module dimension	80.0 x 54.0 x 9.5	mm
View area	70.7 x 38.8	mm
Active area	66.54 x 33.26	mm
Dot size	0.24 x0.24	mm
Dot pitch	0.26 x 0.26	mm
LCD type	FSTN Negative (Double film) Transmissive (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)	
Drive Method	1/128 DUTY,1/12 BIAS	
View direction	6 o'clock	
Backlight Type	LED, White	
IC	ST75256i	
Interface	4-Line SPI/IIC/8-bit 6800/8-bit 8080	

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	—	+70	℃
Storage Temperature	T_{ST}	-30	—	+80	℃
MPU Interface Input Voltage	V_{IN}	-0.3	—	$V_{DD}+0.3$	V
Digital Power Supply Voltage	V_{DD}-Vss	-0.3	—	4.0	V
LCD Power supply voltage	V0- XV0	-0.3	—	19.0	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	V_{DD}-V_{SS}	—	3.0	3.3	3.6	V
Supply Voltage For LCM	V_{OP}	Ta=-20℃	—	—	—	V
		Ta=25℃	14.2	14.5	14.8	V
		Ta=70℃	—	—	—	V
Input High Volt.	V_{IH}	—	0.7 V_{DD}	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	V_{SS}	—	0.3 V_{DD}	V
Output High Volt.	V_{OH}	—	0.8 V_{DD}	—	V_{DD}	V
Output Low Volt.	V_{OL}	—	V_{SS}	—	0.2 V_{DD}	V
Supply Current	I_{DD}	V_{DD}=3.3V	—	1.5	—	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

6.Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	θ	CR≧2	0	—	30	$\phi = 180°$
	θ	CR≧2	0	—	60	$\phi = 0°$
	θ	CR≧2	0	—	45	$\phi = 90°$
	θ	CR≧2	0	—	45	$\phi = 270°$
Contrast Ratio	CR	—	—	5	—	—
Response Time	T rise	—	—	200	300	ms
	T fall	—	—	250	350	ms

Definition of Operation Voltage (Vop)   **Definition of Response Time (Tr , Tf)**
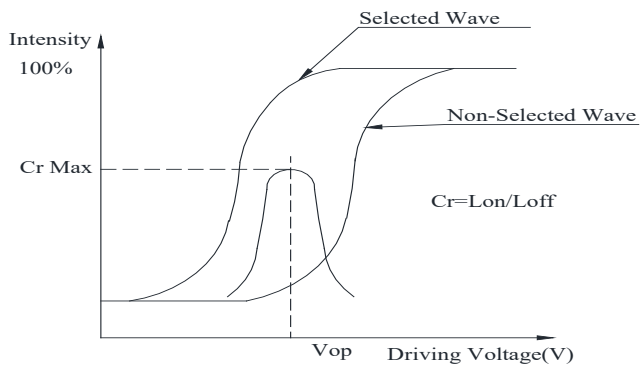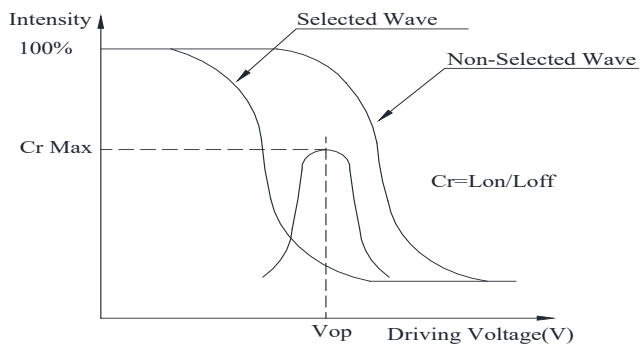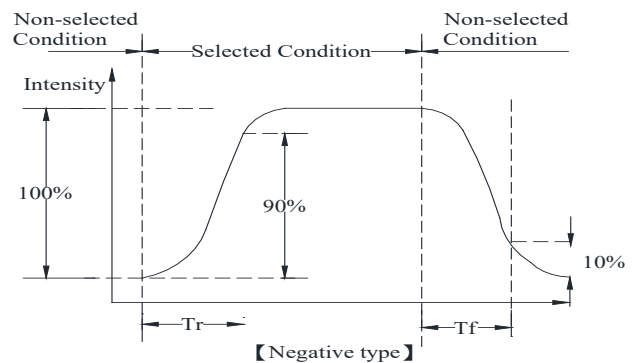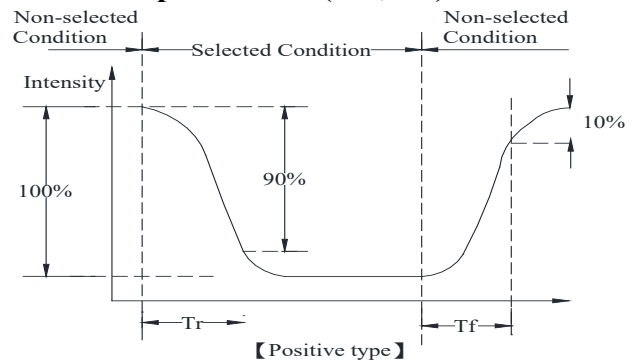
Conditions :

Operating Voltage : Vop   Viewing Angle(θ ，φ) : 0°， 0°
Frame Frequency : 64 HZ   Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle(CR≧2)
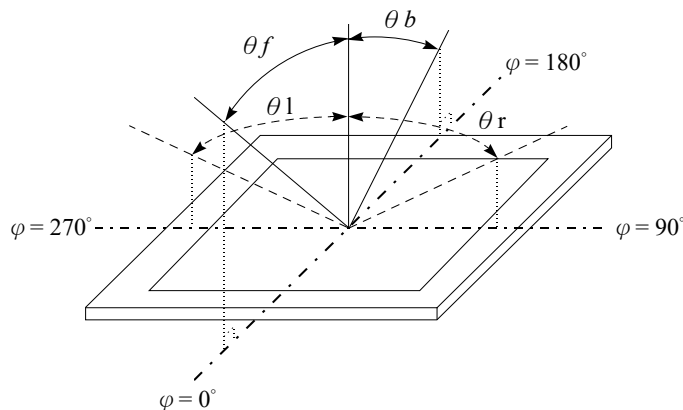
7.Interface Pin Function

Pin No.	Symbol	Description
1	ITOGND	ESD PIN
2	VG	Power of SEG-drivers
3	V0	Positive operating voltage of COM-drivers
4	XV0	Negative operating voltage of COM-drivers
5	CA1P	DC/DC Voltage converte pin
6	CA1N	DC/DC Voltage converte pin
7	VDDA	+3.3V
8	VDD	+3.3V
9	VSS	ground
10	COMSCN	Set scan directing of COM
11	IF1	These pins select interface operation mode. | IF1	IF0	MPU interface type
-----	-----	---------------------
L	L	4-line serial interface
L	H	IIC serial interface
H	L	8-bit 6800 parallel interface
H	H	8-bit 8080 parallel interface | Note: Refer to "Parallel / Serial Interface" for detailed information.
12	IF0	
13	CSB	Chip select input pin
14	A0	Whether the access is related to data or command
15	ERD	Read or write enable terminal
16	RWR	Read/Write execution control pin
17	RSTB	Reset input pin
18~25	D0~D7	Data bus line
26	ITOGND	ESD PIN

8.Contour Drawing

PIN NO.	SYMBOL
1	ITOGND
2	VG
3	V0
4	XV0
5	CA1P
6	CA1N
7	VDDA
8	VDD
9	VSS
10	COMSCN
11	IF1
12	IF0
13	CSB
14	A0
15	ERD
16	RWR
17	RSTB
18	D0
19	D1
20	D2
21	D3
22	D4
23	D5
24	D6
25	D7
26	ITOGND

256x128 DOTS

Pull tape

DETAIL B
SCALE 2/1

Contact Side
SCALE 3/2

Supporting tape   Contact side

DOT SIZE
SCALE 15/1

The non-specified tolerance of dimension is ±0.3mm.

9.Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

Environmental Test			
Test Item	**Content of Test**	**Test Condition**	**Note**
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	— —
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60℃,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20℃　　25℃　　70℃ 30min　5min　30min 1 cycle	-20℃/70℃ 10 cycles	— —
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	— —

Note1: **No dew condensation to be observed.**

Note2: **The function test shall be conducted after 4 hours storage at the normal**
Temperature and humidity after remove from the test chamber.

Note3: **The packing have to including into the vibration testing.**
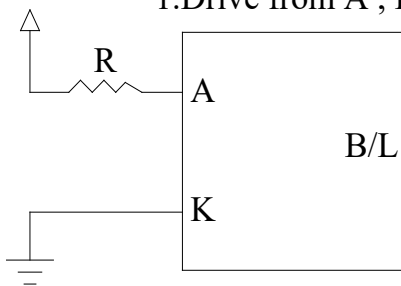
10.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	—	96	120	mA	V=3.5V
Supply Voltage	V	3.3	3.5	3.7	V	—
Reverse Voltage	VR	—	—	5	V	—
Luminance (Without LCD)	IV	840	1050	—	CD/M^2	ILED=96mA
LED Life Time (For Reference only)	—	—	50K	—	Hr.	ILED=96mA 25℃,50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only.
   drive voltage can make driving current under safety area (current between
   minimum and maximum).
Note 1:50K hours is only an estimate for reference.
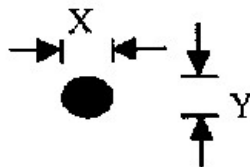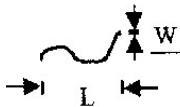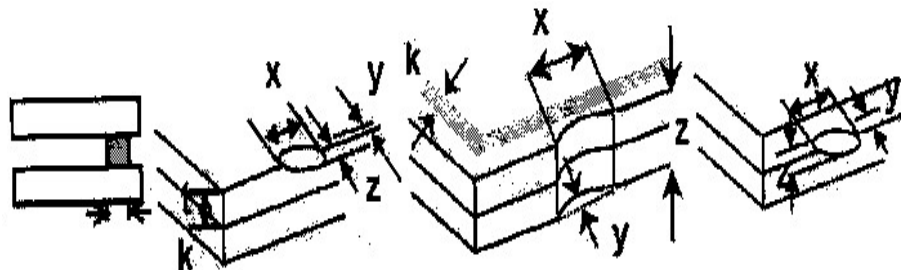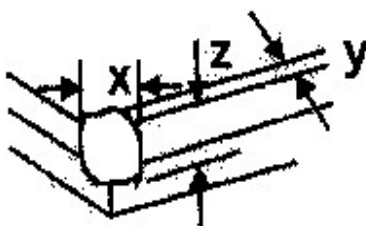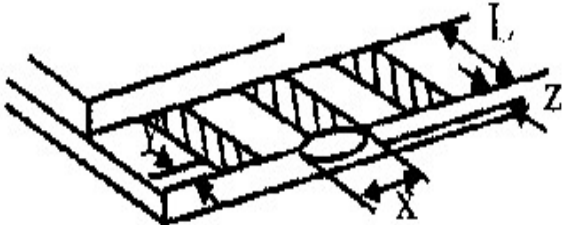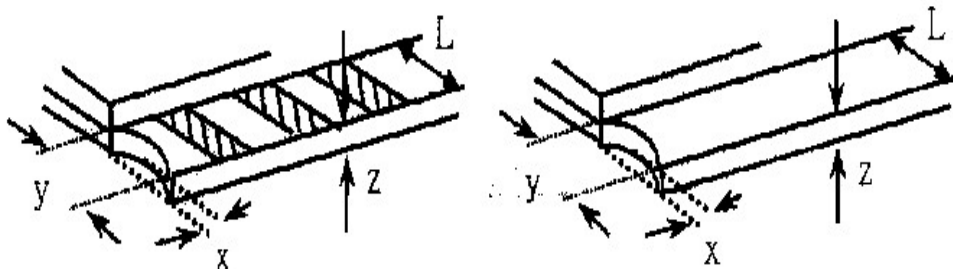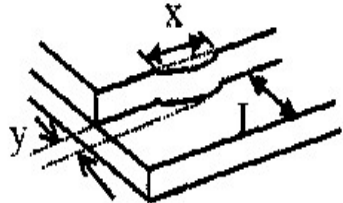
LED B\L Drive Method
1.Drive from A , K
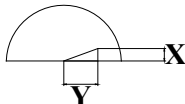
11.Inspection specification

NO	Item	Criterion	AQL
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character , dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.	0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display $\leqq 0.25$mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5

03 LCD black spots, white spots, contamination (non-display)

3.1 Round type : As following drawing

$\Phi=(x + y) / 2$

SIZE	Acceptable Q TY
$\Phi\leqq 0.10$	Accept no dense
$0.10<\Phi\leqq 0.20$	2
$0.20<\Phi\leqq 0.25$	1
$0.25<\Phi$	0

AQL: 2.5

3.2 Line type : (As following drawing)

Length	Width	Acceptable Q TY
---	$W\leqq 0.02$	Accept no dense
$L\leqq 3.0$	$0.02<W\leqq 0.03$	2
$L\leqq 2.5$	$0.03<W\leqq 0.05$	
---	$0.05<W$	As round type

AQL: 2.5

04 Polarizer bubbles

If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.

Size Φ	Acceptable Q TY
$\Phi\leqq 0.20$	Accept no dense
$0.20<\Phi\leqq 0.50$	3
$0.50<\Phi\leqq 1.00$	2
$1.00<\Phi$	0
Total Q TY	3

AQL: 2.5

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	
06	Chipped glass	Symbols Define: x: Chip length　　　y: Chip width　　　z: Chip thickness k: Seal width　　　t: Glass thickness　　a: LCD side length L: Electrode pad length: 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels: ⊙If there are 2 or more chips, x is total length of each chip. 6.1.2 Corner crack: 	2.5

Table for 6.1.1:

z: Chip thickness	y: Chip width	x: Chip length
$Z \leqq 1/2t$	Not over viewing area	$x \leqq 1/8a$
$1/2t < z \leqq 2t$	Not exceed 1/3k	$x \leqq 1/8a$

⊙If there are 2 or more chips, x is total length of each chip.

Table for 6.1.2:

z: Chip thickness	y: Chip width	x: Chip length
$Z \leqq 1/2t$	Not over viewing area	$x \leqq 1/8a$
$1/2t < z \leqq 2t$	Not exceed 1/3k	$x \leqq 1/8a$

⊙If there are 2 or more chips, x is the total length of each chip.

NO	Item	Criterion	AQL
06	Glass crack	Symbols : x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad :	2.5

6.2.1 Chip on electrode pad :

y: Chip width	x: Chip length	z: Chip thickness
$y \leq 0.5mm$	$x \leq 1/8a$	$0 < z \leq t$

6.2.2 Non-conductive portion:

y: Chip width	x: Chip length	z: Chip thickness
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$

⊙If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
⊙If the product will be heat sealed by the customer, the alignment mark not be damaged.

6.2.3 Substrate protuberance and internal crack.

y: width	x: length
$y \leq 1/3L$	$x \leq a$

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit.	0.65
		8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.	2.5
		8.3 Backlight doesn't light or color wrong.	0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.	2.5
		9.2 Bezel must comply with job specifications.	0.65
10	PCB、COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	0.65
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5
		10.5 No oxidation or contamination PCB terminals.	2.5
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB $X * Y <= 2mm^2$	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation or icicle.	2.5
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

   Exhibit A：The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.										

2.Process for RoHS requirement：**(only for RoHS inspection)**

   (1) Use the Sn/Ag/Cu soldering surface；the surface of Pb-free solder is rougher than we used before.

   (2) Heat-resistance temp.：

   Reflow：250℃,30 seconds Max.；

   Connector soldering wave or hand soldering：320℃, 10 seconds max.

   (3) Temp. curve of reflow, max. Temp.：235±5℃；

   Recommended customer's soldering temp. of connector：280℃, 3 seconds.

13.Recommendable Storage

1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH

2. Do not place the module near organics solvents or corrosive gases.

3. Do not crush, shake, or jolt the module.

1、Panel Specification：

   1.   Panel Type：   ☐ Pass   ☐ NG , _____

   2.   View Direction：   ☐ Pass   ☐ NG , _____

   3.   Numbers of Dots：   ☐ Pass   ☐ NG , _____

   4.   View Area：   ☐ Pass   ☐ NG , _____

   5.   Active Area：   ☐ Pass   ☐ NG , _____

   6.   Operating Temperature：   ☐ Pass   ☐ NG , _____

   7.   Storage Temperature：   ☐ Pass   ☐ NG , _____

   8.   Others： _____

2、Mechanical Specification：

   1.   PCB Size：   ☐ Pass   ☐ NG , _____

   2.   Frame Size：   ☐ Pass   ☐ NG , _____

   3.   Materal of Frame：   ☐ Pass   ☐ NG , _____

   4.   Connector Position：   ☐ Pass   ☐ NG , _____

   5.   Fix Hole Position：   ☐ Pass   ☐ NG , _____

   6.   Backlight Position：   ☐ Pass   ☐ NG , _____

   7.   Thickness of PCB：   ☐ Pass   ☐ NG , _____

   8.   Height of Frame to PCB：   ☐ Pass   ☐ NG , _____

   9.   Height of Module：   ☐ Pass   ☐ NG , _____

   10.   Others：   ☐ Pass   ☐ NG , _____

3、Relative Hole Size：

   1.   Pitch of Connector：   ☐ Pass   ☐ NG , _____

   2.   Hole size of Connector：   ☐ Pass   ☐ NG , _____

   3.   Mounting Hole size：   ☐ Pass   ☐ NG , _____

   4.   Mounting Hole Type：   ☐ Pass   ☐ NG , _____

   5.   Others：   ☐ Pass   ☐ NG , _____

4、Backlight Specification：

   1. B/L Type：   ☐ Pass   ☐ NG , _____

   2. B/L Color：   ☐ Pass   ☐ NG , _____

   3. B/L Driving Voltage (Reference for LED Type)：   ☐ Pass   ☐ NG , _____

   4. B/L Driving Current：   ☐ Pass   ☐ NG , _____

   5. Brightness of B/L：   ☐ Pass   ☐ NG , _____

   6. B/L Solder Method：   ☐ Pass   ☐ NG , _____

   7. Others：   ☐ Pass   ☐ NG , _____

<div align="center">＞＞ Go to page 2 ＜＜</div>

5、<u>Electronic Characteristics of Module</u>：

1. Input Voltage：   ☐ Pass   ☐ NG ,_____
2. Supply Current：   ☐ Pass   ☐ NG ,_____
3. Driving Voltage for LCD： ☐ Pass   ☐ NG ,_____
4. Contrast for LCD：   ☐ Pass   ☐ NG ,_____
5. B/L Driving Method：   ☐ Pass   ☐ NG ,_____
6. Negative Voltage Output： ☐ Pass   ☐ NG ,_____
7. Interface Function：   ☐ Pass   ☐ NG ,_____
8. LCD Uniformity：   ☐ Pass   ☐ NG ,_____
9. ESD test：   ☐ Pass   ☐ NG ,_____
10. Others：   ☐ Pass   ☐ NG ,_____

6、<u>Summary</u>：

Sales signature：_____
Customer Signature：_____   **Date**：___/___/___

14.External Power Supply Circuit

CN1

Pin	Signal
1	ITOGND
2	VG
3	V0
4	XV0
5	CA1P
6	CA1N
7	VDDA
8	VDD
9	VSS
10	COMSCN
11	IF1
12	IF0
13	CSB
14	A0
15	ERD
16	RWR
17	RSTB
18	D0
19	D1
20	D2
21	D3
22	D4
23	D5
24	D6
25	D7
26	ITOGND

WO256128A INTERFACE

CV0 0.1UF
CVG 0.1UF
C1 0.1UF